

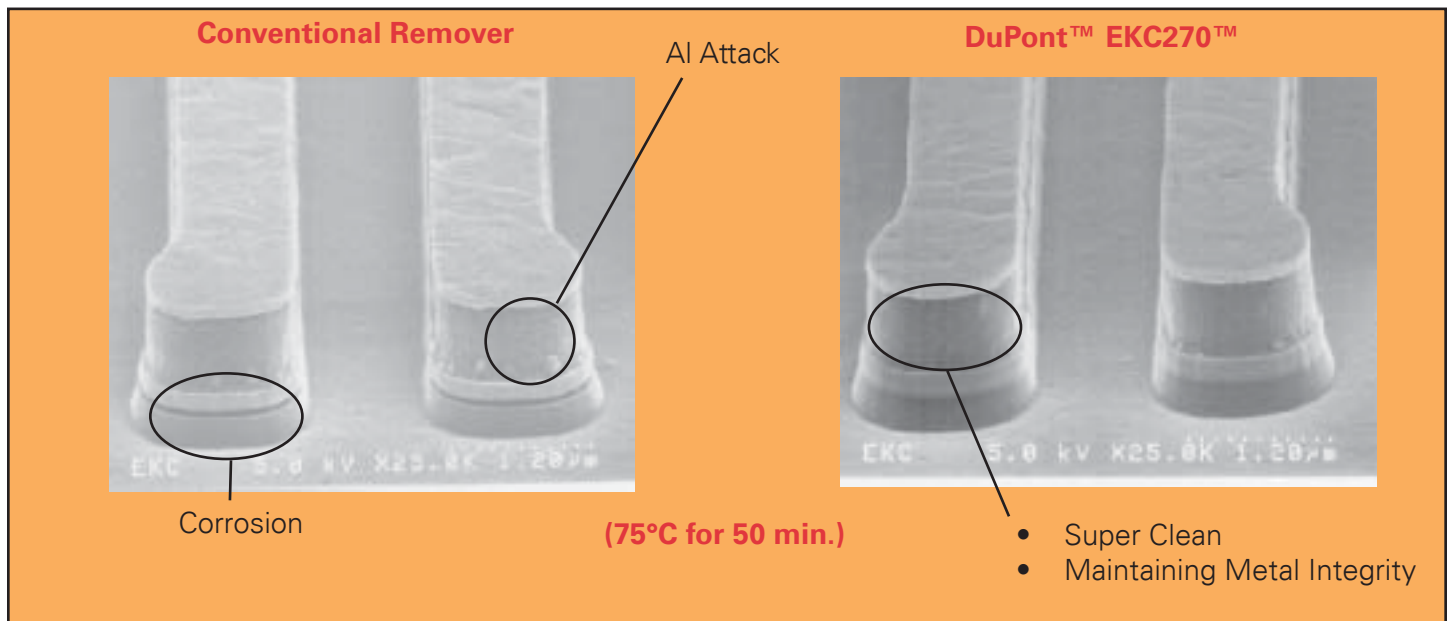
# DuPont™ PlasmaSolv® EKC270™ post-etch residue remover

## Made with DuPont™ HDA® hydroxylamine technology for enhanced performance

DuPont™ PlasmaSolv® EKC270™ post-etch residue remover is made with DuPont™ HDA® hydroxylamine technology for enhanced performance

### Benefits

- Formulated for optimum metal stack integrity
- "Improved" wide window process capability
- Enhanced post etch residue removal
- Patented and patent pending improved reduction chemistry
- Ultra Large Scale Integration (ULSI) grade specifications for advanced wafer cleaning
- Low evaporation rate at operating temperature



DuPont™ PlasmaSolv® EKC270™ demonstrates superior performance, even under aggressive processing conditions



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For more information on DuPont™ PlasmaSolv® EKC270™ post-etch residue remover or other DuPont EKC Technology products, please contact your local representative, or visit our website:

Americas

DuPont Electronic Technologies  
EKC Technology, Inc.  
2520 Barrington Court  
Hayward, CA 94545  
Tel: 510 784 9105

Taiwan

EKC Technology  
No. 2, LiHsing 4th Road  
Science-Based Industrial Park  
Hsinchu, Taiwan R.O.C.  
Tel: 866 357 90550  
Fax: 866 357 98857

Japan

EKC Technology, K.K.  
KSP R&D D3 42  
3-2-1 Sakado, Takatsu-ku, Kawasaki  
Kanagawa, 213-0012 Japan  
Tel: 81 44 850 8215

European Sales & Support

EU Technical Support: 44 (0) 16 98 26 69 46  
EU Sales Support: 44 (0) 15 55 72 80 84  
EU Fax: 44 (0) 13 13 41 10 43

[www.ekctech.com](http://www.ekctech.com)

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Caution: Do not use in medical applications involving permanent implantation in the human body. For other medical applications, see "DuPont Medical Caution Statement: H-51459 or H-50102-2"

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